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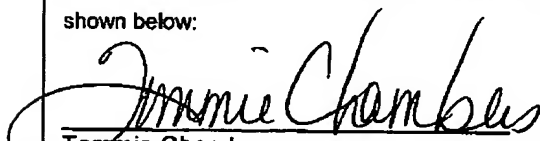
From: W. Daniel Swayze, Jr.
Texas Instruments Incorporated
Facsimile: 972-917-4418
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NAME OF INVENTOR(S): Sheperok		RECEIPT DATE & SERIAL NO.:	
TITLE OF INVENTION: TEMPERATURE COMPENSATION SYSTEMS AND METHODS FOR USE WITH READ/WRITE HEADS IN MAGNETIC STORAGE DEVICES		Serial No.: 10/736,661	
TI FILE NO.:	DEPOSIT ACCT. NO.:	Filing Date: 12/16/2003	
TI-36723	20-0668		
FAXED: 03/21/2006			
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Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265